

190403491 Addendum to PCN 180216170 Adding 2nd Assembly & Test F85x, F86x, BB1 QFN20

PCN Issue Date: 4/3/2019

Effective Date: 7/9/2019

PCN Type: Assembly; Test

Description of Change

This addendum is to add the C8051F850 Y grade part numbers as part of PCN 180216170 Adding Second Assembly & Test Source C8051F85x, C8051F86x, EFM8BB1 QFN20.

"Silicon Labs is pleased to announce the successful qualification of Advanced Semiconductor Engineering ChungLi (ASECL) as an additional IC assembly and test site for C8051F85x, C8051F86x, and EFM8BB1 in QFN20 packages. ASECL is an existing IC assembly supplier for Silicon Labs, certified and registered to ISO9001, ISO14001 and TS16949.

After the PCN effective date, Silicon Labs will ship product from either qualified assembly site."

Reason for Change

Including additional OPNs that were left out from the original PCN.

Impact on Form, Fit, Function, Quality, Reliability

There is no impact on fit, function, quality, or reliability. The form has changed to include Cu wire bonds.

Product Identification

C8051F850-C-YM C8051F850-C-YMR EFM8BB10F4G-A-QFN20 EFM8BB10F4G-A-QFN20R EFM8BB10F4I-A-QFN20 EFM8BB10F4I-A-QFN20R EFM8BB10F8G-A-QFN20 EFM8BB10F8G-A-QFN20R EFM8BB10F8I-A-QFN20 EFM8BB10F8I-A-QFN20R EFM8BB10F2G-A-QFN20 EFM8BB10F2G-A-QFN20R EFM8BB10F2I-A-QFN20 EFM8BB10F2I-A-QFN20R EFM8BB10M1039F8GM-A EFM8BB10M1039F8GM-AR EFM8BB10M1069F8GM-A EFM8BB10M1069F8GM-AR EFM8BB10P1012F2GM-A EFM8BB10P1012F2GM-AR EFM8BB10P1072F4GM-A EFM8BB10P1072F4GM-AR C8051F850-C-GM C8051F850-C-GMR C8051F850-C-IM C8051F850-C-IMR

C8051F851-C-GM C8051F851-C-GMR C8051F851-C-IM C8051F851-C-IMR C8051F852-C-GM C8051F852-C-GMR C8051F852-C-IM C8051F852-C-IMR C8051F853-C-GM C8051F853-C-GMR C8051F853-C-IM C8051F853-C-IMR C8051F854-C-GM C8051F854-C-GMR C8051F854-C-IM C8051F854-C-IMR C8051F855-C-GM C8051F855-C-GMR C8051F855-C-IM C8051F855-C-IMR CF850P1102CGM CF850P1102CGMR

Last Date of Unchanged Product: 7/9/2019

Qualification Samples

Available on request.

Customer Response

Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change, Ref. JEDEC-J-STD-046.

To request further data or inquire about this notification, please contact your Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at http://www.silabs.com.

Customers may approve early PCN acceptance by emailing approval, along with PCN # to PCNEarlyAcceptance@silabs.com

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Qualification Data

See attached qualification reports below.

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C8051F85x.8	6x Rev C, GSMC Fabrica	tion, UTACTH	and ASE	CL Assemb	ly excep	ot as note	d
				Fail/Pass or			
Test Name	Test Condition	Qualification	Start	End	Notes	Summary	Status
Test Group A - A	ccelerated Environment Stres	s Tests - 24-QSOP	- UTACTH	CuPd Wire			
тнв	JA101		Q34377	0/79	1		
	85°C, 85%RH	3 lots, N=>77	Q34374	0/80	1	3 lots	
	Vcc=3.6V, 1000 hours		Q34090	0/80	1	0/239	Pass
UHAST	JA110		Q34376	0/80	1		
	130°C, 85%RH	3 lots, N≕>77	Q34373	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q34089	0/80	1	0/240	Pass
Temp Cycle	JA104		Q34375	0/80	1		
	Cond C: -65°C to 150°C	3 lots, N≕>77	Q34372	0/80	1	3 lots	
	500 cycles		Q34088	0/80	1	0/240	Pass
HTSL	JA103		Q34120	0/81	1		
	150°C, 1000hr	1 lot, N=>45	Q34432	0/85	1	2 lots	
						0/166	Pass
Test Group A - A	ccelerated Environment Stres	s Tests - 20-QFN-	3x3 - UTAC	TH Au Wire			
HAST	JA110		Q34390	0/80	1		
	130°C, 85%RH	3 lots, N=>77	Q34384	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q34193	0/80	1	0/240	Pass
UHAST	JA110		Q34386	0/80	1		
	130°C, 85%RH	3 lots, N=>77	Q34383	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q34184	0/80	1	0/240	Pass
Temp Cycle	JA104		Q34385	0/80	1		
	Cond C: -65°C to 150°C	3 lots, N=>77	Q34382	0/80	1	4 lots	
	500 cycles		Q34192	0/80	1	0/317	Pass
			Q40860	0/77	1		
HTSL	JA103						
	150°C, 1000hr	1 lot, N=>45	Q34342	0/50	1	1 lots	
						0/50	Pass

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C8051F85x.8	86x Rev C, GSMC Fabrica	tion, UTACTH	l and ASE	CL Assemb	ly exce	pt as noted	1
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status
Test Group A - A	ccelerated Environment Stres	s Tests - 20-QFN-	3x3 - ASEC	L CuPd Wire			
HAST	JA110		Q035864	0/80	1		
	130°C, 85%RH	3 lots, N=>77	Q035863	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q035862	0/80	1	0/240	Pass
UHAST	JA110		Q035861	0/84	1		
	130°C, 85%RH	3 lots, N≈≻77	Q035859	0/85	1	3 lots	
	Vcc=3.6V, 192 hours		Q035858	0/81	1	0/250	Pass
Temp Cycle	JA104		Q035857	0/85	1		
	Cond C: -65°C to 150°C	3 lots, N≕>77	Q035856	0/78	1	3 lots	
	500 cycles		Q035855	0/85	1	0/248	Pass
HTSL	JA103		Q035854	0/30	1		
	150°C, 1000hr	1 lot, N=>45	Q035847	0/30	1	3 lots	
			Q035846	0/30	1	0/90	Pass
Test Group A - A	ccelerated Environment Stres	s Tests - 16-SOIC	- UTACTH	Au Wire			
HAST	JA110		Q34364	0/78	1		
	130°C, 85%RH	3 lots, N=>77	Q34361	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q34191	0/80	1	0/238	Pass
UHAST	JA110		Q34363	0/80	1		
	130°C, 85%RH	3 lots, N=>77	Q34359	0/80	1	3 lots	
	Vcc=3.6V, 96 hours		Q34189	0/78	1	0/238	Pass
Temp Cycle	JA104		Q34362	0/80	1		
	Cond C: -65°C to 150°C	3 lots, N≕>77	Q34360	0/80	1	3 lots	
	500 cycles		Q34190	0/80	1	0/240	Pass
HTSL	JA103						
	150°C, 1000hr	1 lot, N=>45	Q34334	0/50	1	1 lots	
						0/50	Pass

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C8051F85x.8	C8051F85x.86x Rev C, GSMC Fabrication, UTACTH and ASECL Assembly except as noted						
			Lot ID or	Fail/Pass or			
Test Name	Test Condition	Qualification	Start	End	Notes	Summary	Status
	ccelerated Lifetime Simulation	on Tests					
HTOL			Q34435	0/15	6		
	JA108		Q34434	0/84	6		
	125°C, Dynamic	3 lots, N=>77	Q34753	0/99	6	4 lots	
	Vcc=3.6V, 1000 hours		Q34773	0/88	6	0/286	Pass
ELFR	AEC-Q100-008		Q34414	0/809			
	125°C, Dynamic	3 lots, N=>800	Q34752	0/826		3 lots	
	Vcc=3.6V, 48 hours		Q34012	0/829		0/2464	Pass
HTDR			Q34432	0/85	6		
	AEC-Q100-005		Q34433	0/15	6		
	150°C, 1000 hours	3 lots, N=>77	Q34775	0/99	6	7 lots	
			Q34774	0/100	6	0/579	Pass
			Q35080	0/86	8		
			Q35081	0/87	8		
			Q35249	0/107	8		
LTDR			Q34436	0/82	7		
	AEC-Q100-005		Q34778	0/100	7		
	25°C, 1000 hours	3 lots, N=>77	Q34776	0/100	7	4 lots	
			Q34437	0/15	7	0/297	Pass
Test Group E - El	ectrical Verification						
ESD-HBM	AEC-Q100-002						
		1 lot, N=>3	Q34017				2000 V
ESD-MM	AEC-Q100-003						
		1 lot, N=>3	Q34018				150 V
ESD-CDM	AEC-Q100-011		Q34457		2		1250 V
cso-com	ALC-Q100-011	1 lot. N=>3	034415		3		1250 V
			Q34481		4		1500 V
			Q35881		5		1500 V
Latch Up	AEC-Q100-004	1	-		-		
	±200mA	1 lot, N≕>6	Q34412	125 C			Pass
			Q24413	25 C			
Gate Leakage	AEC-Q100-006						
		1 lot, N=>6	Q34211				Pass

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C8051F85x.86x Rev C, GSMC Fabrication, UTACTH and ASECL Assembly except as noted

C003 11032.00X	Nev C, OSMC Fabricat	uon, otacin	and ASE	CL ASSemb	iy excep	as note	u
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End		Summary	Status

Notes:

1. Parts are Pre-conditioned at MSL2/260°C

2. 16-SOIC

3. 24-QSOP

4. 20-QFN UTACTH

5. 20-QFN ASECL

6. Device are preconditioned with 20K program/erase endurance cycling at 85°C

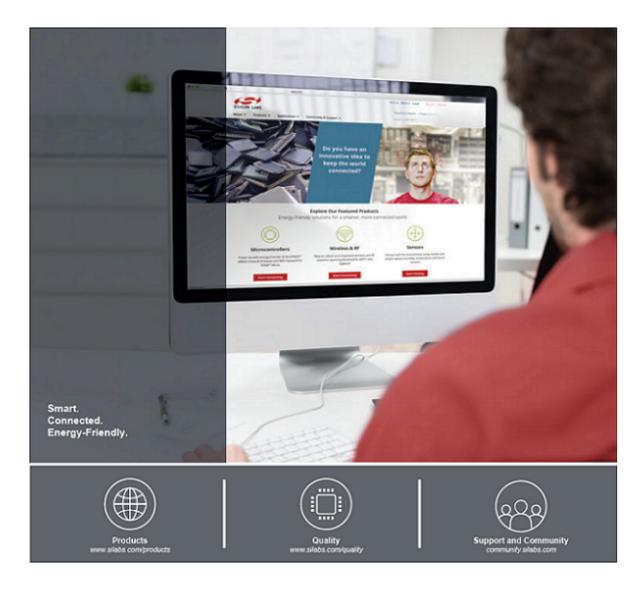
7. Device are preconditioned with 20K program/erase endurance cycling at 55°C

8. Device are preconditioned with 20K program/erase endurance cycling at 125°C

This report applies to the following part numbers:						
C8051F850-C-GM	C8051F850-C-GU	C8051F850-C-IM	C8051F850-C-IU	C8051F850-C-YM		
C8051F851-C-GM	C8051F851-C-GU	C8051F851-C-IM	C8051F851-C-IU	C8051F850-G1DI		
C8051F852-C-GM	C8051F852-C-GU	C8051F852-C-IM	C8051F852-C-IU	C8051F850-GDI		
C8051F853-C-GM	C8051F853-C-GU	C8051F853-C-IM	C8051F853-C-IU			
C8051F854-C-GM	C8051F854-C-GU	C8051F854-C-IM	C8051F854-C-IU			
C8051F855-C-GM	C8051F855-C-GU	C8051F855-C-IM	C8051F855-C-IU			
C8051F860-C-GS	C8051F860-C-IS					
C8051F861-C-GS	C8051F861-C-IS					
C8051F862-C-GS	C8051F862-C-IS					
C8051F863-C-GS	C8051F863-C-IS					
C8051F864-C-GS	C8051F864-C-IS					
C8051F865-C-GS	C8051F865-C-IS					

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